

ZXT1053AK

#### 75V NPN LOW SATURATION MEDIUM POWER TRANSISTOR

#### **Features**

- BV<sub>CEO</sub> > 75V
- I<sub>C</sub> = 5A high Continuous Collector Current
- Up to 10A Peak Current
- R<sub>SAT</sub> = 70mΩ for a low equivalent On-Resistance
- Low Saturation Voltage
- h<sub>FE</sub> specified up to 10A for a high gain hold up
- Lead-Free Finish: RoHS compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

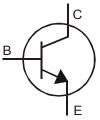
- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- · Weight: 0.34 grams (approximate)

### **Application**

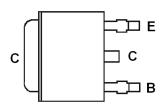
- DC DC converters
- Power Switches
- Motor Control
- Automotive Circuits
- Inverter Circuits



Top View



Device Schematic



Pin Out Configuration Top view

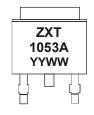
### **Ordering Information** (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXT1053AKTC	ZXT1053A	13	16	2,500

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com

## **Marking Information**



ZXT1053AK = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 09 = 2009) WW = Week Code (01 - 53)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	$V_{CBO}$	150	V
Collector-Emitter Voltage	$V_{CEO}$	75	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ic	5	Α
Peak Pulse Collector Current	I <sub>CM</sub>	10	Α

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

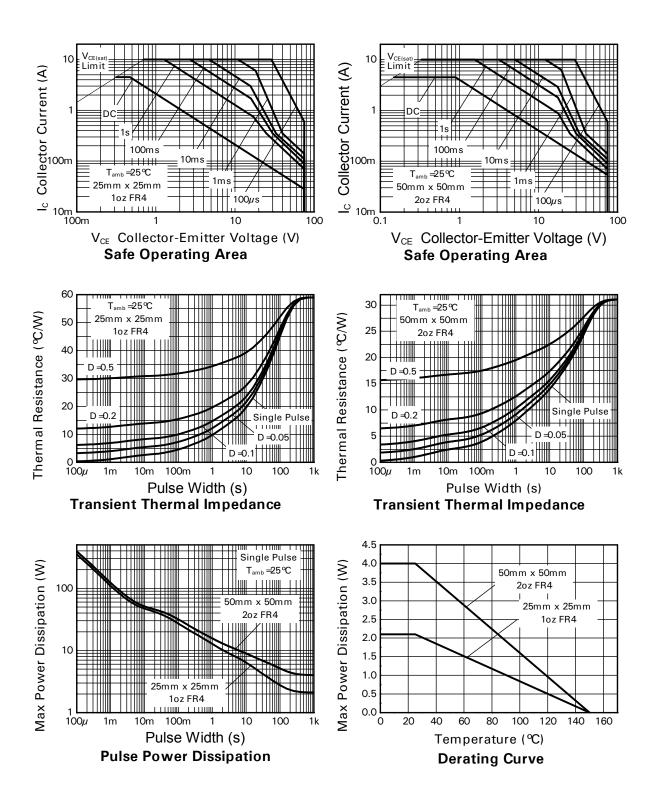
Characteristic	Symbol	Value	Unit		
	(Note 5)		2.1		
Power Dissipation	(Note 6)	$P_{D}$	3.4	W	
	(Note 7)		4.0		
	(Note 5)		59		
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{\theta JA}$	36	°C/W	
	(Note 7)		32		
Thermal Resistance, Junction to Leads	(Note 8)	$R_{ heta JL}$	2.97	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

Notes:

- 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 6. Same as note (5), except the device is surface mounted on 25mm x 25mm with 2oz copper.
- 7. Same as note (5), except the device is surface mounted on 50mm x 50mm with 2oz copper.
- 8. Thermal resistance from junction to solder-point (at the end of the collector lead).



## Thermal Characteristics and Derating Information





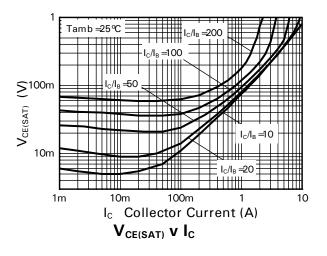
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

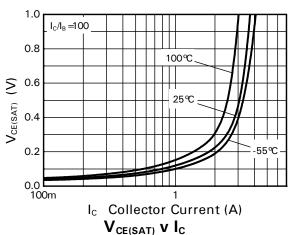
Characteristic	Symbol	Min	Тур.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	150	240	-	V	$I_{C} = 100 \mu A$
Collector-Base Breakdown Voltage	BV <sub>CES</sub>	150	240	-	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV <sub>CEO</sub>	75	90	-	V	I <sub>C</sub> = 10mA
Collector-Emitter Breakdown Voltage	BV <sub>CEV</sub>	150	240		V	$I_{C} = 1\mu A, V_{EB} = 1V$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.7	-	V	$I_E = 100 \mu A$
Collector Cutoff Current	I <sub>CBO</sub>	-	<1	10	nA	V <sub>CB</sub> = 120V
Emitter Cutoff Current	I <sub>EBO</sub>	-	<1	10	nA	V <sub>EB</sub> = 6V
Emitter Cutoff Current	I <sub>CES</sub>	-	<1	10	nA	V <sub>CE</sub> = 120V
DC current transfer Static ratio (Note 9)	h <sub>FE</sub>	260 300 50 10	375 450 75 25	- 1200 - -	-	$I_{C} = 10$ mA, $V_{CE} = 2$ V $I_{C} = 1$ A, $V_{CE} = 2$ V $I_{C} = 5$ A, $V_{CE} = 2$ V $I_{C} = 10$ A, $V_{CE} = 2$ V
Collector-Emitter Saturation Voltage (Note 9)	V <sub>CE(sat)</sub>	- - - -	19 70 120 140 350	30 95 160 190 460	mV	$I_C = 0.2A, I_B = 20mA$ $I_C = 1A, I_B = 100mA$ $I_C = 1A, I_B = 10mA$ $I_C = 2A, I_B = 100mA$ $I_C = 5A, I_B = 200mA$
Base-Emitter Saturation Voltage (Note 9)	V <sub>BE(sat)</sub>	-	1.0	1.1	V	I <sub>C</sub> = 5A, I <sub>B</sub> = 200mA
Base-Emitter Turn-on Voltage (Note 9)	V <sub>BE(on)</sub>	-	0.925	1.05	V	I <sub>C</sub> = 5A, V <sub>CE</sub> = 2V
Transitional Frequency	f <sub>T</sub>	-	140	-	MHz	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V f = 100MHz
Output capacitance	C <sub>OBO</sub>	-	21	30	pF	V <sub>CB</sub> = 10V, f = 1MHz,
Switching times	t <sub>ON</sub> t <sub>OFF</sub>	-	162 900	-	nS	$I_C = 2A, V_{CC} = 50V,$ $I_{B1} = I_{B2} = 20mA$

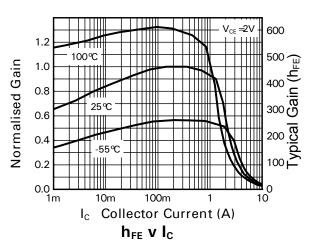
Notes: 9. Measured under pulsed conditions. Pulse width  $\leq$  300 $\mu$ s. Duty cycle  $\leq$ 2%.

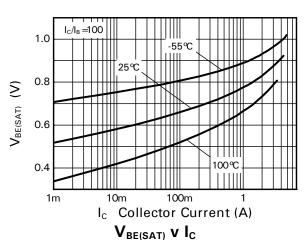


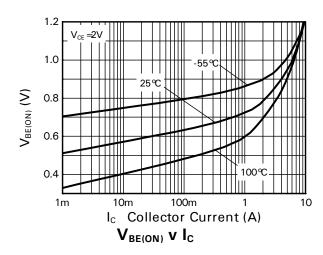
## Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)







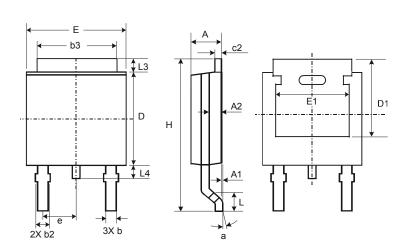






# **Package Outline Dimensions**

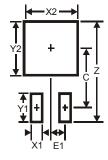
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



TO252					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
<b>A1</b>	0.00	0.13	0.08		
<b>A2</b>	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
c2	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	_	_		
Ф	_	_	2.286		
Е	6.45	6.70	6.58		
E1	4.32	_	_		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	_		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	11.6
X1	1.5
X2	7.0
Y1	2.5
Y2	7.0
С	6.9
E1	2.3





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